

Specification for Approval

Date: 2021/08/16

TAI-TECH P/N:	TMPA0605S-220MN-D
CUSTOMER P/N:	
DESCRIPTION:	
QUANTITY:	

Customer Approval Feedback
Customer Approval Feedback

西北臺慶科技股份有限公司 TAI-TECH Advanced Electronics Co.. Ltd

Sales i

_ 代理商:

深圳市天**诚**科技有限公司 Shenzhen TsaSun Technology Co., Ltd. Room 209, 2/F, Block A, Tengfei Industrial Building, No.6, Taohua Road, Futian District, Shenzhen TEL: 0755-8335 8885 / 0755-8335 9885 E-mail: sales@tsasun.com www.tsacoil.com

□西北臺慶科技股份有限公司

TAI-TECH Advanced Electronics Co., Ltd <u>Headquarter:</u> NO.1 YOU 4TH ROAD, YOUTH INDUSTRIAL DISTRICT, YANG-MEI, TAO-YUAN HSIEN, TAIWAN, R.O.C.

TAC-YUAN HSIEN, TAIWAN, R.O.C. TEL: +886-3-4641148 FAX: +886-3-4643565 http://www.tai-tech.com.tw E-mail: sales@tai-tech.com.tw

□ 臺慶精密電子(昆山)有限公司

TAI-TECH ADVANCED ELECTRONICS(KUNSHAN) CO., LTD SHINWHA ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN, JIANG-SU, CHINA

TEL: +86-512-57619396 FAX: +86-512-57619688

E-mail: hui@tai-tech.com.tw

Sales Dep.

APPROVED	CHECKED
夏暁曼	夏暁曼

R&D Center

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羅宜春	梁周虎	卜文娟

SMD Power Inductor

TMPA0605S-220MN-D

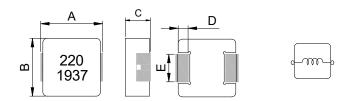
1. Features

- 1. Shielded construction.
- 2. Capable of corresponding high frequency.
- 3. Low loss realized with low DCR.
- 4. High performance (Isat) realized by metal dust core.
- 5. Ultra low buzz noise, due to composite construction.
- 6. 100% Lead(Pb)-Free and RoHS compliant.
- 7. Operating temperature -40~+125 $^{\circ}\text{C}\textsc{(Including self temperature rise)}$

2. Applications

- 1. DC/DC converters in distributed power systems.
- 2. DC/DC converter for Field Programmable Gate Array(FPGA).
- 3. Battery powered devices.
- 4. Thin type on-board power supply module for exchanger.
- 5. VRM for server.
- 6. High current, low profile POL converters.
- 7. PDA/notebook/desktop/server and battery powered devices.

3. Dimensions



Series	Α	В	С	D	E
TMPA0605	7.3±0.3	6.6±0.3	4.8±0.2	1.6±0.3	3.0±0.2

Unit:mm

4. Part Numbering

TMPA 0605 S - 220 MN - D
A B C D E F

A: Series

 B: Dimension
 BxC

 C: Type
 Standard.

 D: Inductance
 220=22.0uH

 E: Inductance Tolerance
 M=±20%

F: Code Marking: Black.220 and 1937(19 YY,37WW,follow production date).

5. Specification

Part Number	Inductance L0 A(uH) ±20%	Heat Rating Current DC I rms (A)		Saturation Current DC I sat (A)		DCR (mΩ)Typ	DCR (mΩ)Max
	Typ Max		Тур	Max			
TMPA0605S-220MN-D	22.0	4.2	3.6	3.6	3.1	122.0	142.0

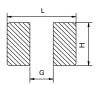
Note:

- 1. Test frequency : Ls : 100KHz /1.0V.
- 2. All test data referenced to $25\,^\circ\!\mathbb{C}\,$ ambient.
- 3. Testing Instrument(or equ): L: HP4284A,CH11025,CH3302,CH1320,CH1320S LCR METER / Rdc:CH16502,Agilent33420A MICRO OHMMETER.
- 4. Heat Rated Current (Irms) will cause the coil temperature rise approximately ΔT of 40°C
- 5. Saturation Current (Isat) will cause L0 to drop approximately 30%.
- 6. The part temperature (ambient + temp rise) should not exceed 125 °C under worst case operating conditions. Circuit design, component, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.
- 7. Special inquiries besides the above common used types can be met on your requirement.









L(mm)	G(mm)	H(mm)
8.0	3.5	3.4

Note: 1. The above PCB layout reference only.
2. Recommend solder paste thickness at
0.15mm and above.

6. Material List



NO	Items	Materials			
1	Core	Alloy Powder .			
2	Wire	Polyester Wire or equivalent.			
3	Clip	100% Pb free solder(Ni+SnPlating)			
4	Ink	Halogen-free ketone			

7. Reliability and Test Condition

Item	Performance	Test Condition
Operating temperature	-40~+125℃ (Including self - temperature rise)	
Storage temperature	110~+40°C ,50~60%RH (Product with taping) 240~+125°C (on board)	
Electrical Performance	Test	
Inductance		HP4284A,CH11025,CH3302,CH1320,CH1320S LCR Meter.
DCR	Refer to standard electrical characteristics list.	CH16502,Agilent33420A Micro-Ohm Meter.
Saturation Current (Isat)	Approximately △L30%.	Saturation DC Current (Isat) will cause L0 to drop \triangle L(%)
Heat Rated Current (Irms)	Approximately △T40°C	Heat Rated Current (Irms) will cause the coil temperature rise △T(ℂ). 1.Applied the allowed DC current 2.Temperature measured by digital surface thermometer
Reliability Test		
Life Test		Preconditioning: Run through IR reflow for 2 times, (IPC/JEDECJ-STD-020DClassification Reflow Profiles) Temperature: 125±2°C (Inductor) Applied current: rated current Duration: 1000±12hrs Measured at room temperature after placing for 24±2 hrs.
Load Humidity		Preconditioning: Run through IR reflow for 2 times, (IPC/JEDECJ-STD-020DClassification Reflow Profiles) Humidity: $85\pm2\%$ R.H, Temperature: $85\%\pm2\%$ Duration: 1000hrs Min. with 100% rated current Measured at room temperature after placing for 24 ±2 hrs.
Moisture Resistance	Appearance: No damage. Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDECJ-STD-020DClassification Reflow Profiles) 1. Baked at50°C for 25hrs, measured at room temperature afte placing for 4 hrs. 2. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs. 3. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs. 4. Start St
Thermal shock		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDECJ-STD-020DClassification Reflow Profiles) Condition for 1 cycle Step1: $-40\pm2^{\circ}$ C 30 \pm 5min Step2: $-25\pm2^{\circ}$ C $=0.5$ min Step3: $-125\pm2^{\circ}$ C 30 \pm 5minNumber of cycles: -500
Vibration		Measured at room fempraturc after placing for 24±2 hrs. Preconditioning: Run through IR reflow for 2 times, (IPC/JEDECJ-STD-020DClassification Reflow Profiles) Oscillation Frequency: 10Hz~2KHz~10Hz for 20 minutes Equipment: Vibration checker Total Amplitude: 10g Testing Time: 12 hours(20 minutes, 12 cycles each of 3 orientations).

TAI-TECH

Item	Performance	Test Condition				
Bending	Appearance : No damage. Impedance : within±15% of initial value	Shall be mounted on a FR4 substrate of the following dimensions: >=0805 inch(2012mm):40x100x1.2mm <0805 inch(2012mm):40x100x0.8mm Bending depth: >=0805 inch(2012mm):1.2mm <0805 inch(2012mm):0.8mm duration of 10 sec.				
	Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not	Type Peak Value duration (D) Wave change (Vi)ft/sec				
Shock	exceed the specification value	SMD 50 11 Half-sine 11.3				
		Lead 50 11 Half-sine 11.3				
Solder ability	More than 95% of the terminal electrode should be covered with solder.	Preheat: 150°C,60sec.。 Solder: Sn96.5% Ag3% Cu0.5% Temperature: 245±5°C ∘ Flux for lead free: Rosin. 9.5% ∘ Dip time: 4±1sec ∘ Depth: completely cover the termination				
Resistance to Soldering Heat		Depth: completely cover the termination Temperature (°C) Time(s) Temperature ramp/immersion and emersion rate Number of heat cycles				
		260 ±5 (solder temp) 10 ±1 25mm/s ±6 mm/s 1				
Terminal Strength	Appearance: No damage. Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not exceed the specification value e	Preconditioning: Run through IR reflow for 2 times.(IPC/JEI J-STD-020DClassification Reflow Profiles With the component mounted on a PCB with the device to tested, apply a force(>0805:1kg), <=0805:0.5kg)to the side device being tested. This force shall be applied for 60 seconds. Also the force shall be applied gradually as no apply a shock to the component being tested.				

Note: When there are questions concerning measurement result: measurement shall be made after 48 ± 2 hours of recovery under the standard condition.

8. Soldering and Mounting

(1) Soldering

Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. TAI-TECH terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

(2) Solder re-flow:

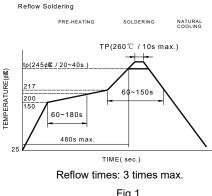
Recommended temperature profiles for re-flow soldering in Figure 1.

(3) Soldering Iron:

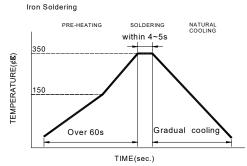
Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

- · Never contact the ceramic with the iron tip
- · Use a 20 watt soldering iron with tip diameter of 1.0mm

- 355℃ tip temperature (max)
- 1.0mm tip diameter (max)
- · Limit soldering time to 4~5sec.







Iron Soldering times: 1 times max.

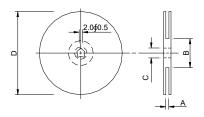
Fig.2

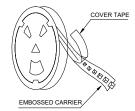
9. Friendly reminder

- (1) When there are questions concerning measurement result : measurement shall be made after 48 \pm 2 hours of recovery under the standard condition
- (2) This power choke coil itself does not have any protective function in abnormal condition such as overload, short-circuit and open-circuit conditions, etc. Therefore, it shall be confirmed as the end product that there is no risk of smoking, fire, dielectric withstand voltage, insulation resistance, etc. in abnormal conditions to provide protective devices and/or protection circuit in the end product.
- (3) When this power choke coil was used in a similar or new product to the original one, sometimes it might not be able to satisfy the specifications due to different condition of use.
- (4) Dielectric withstanding test with higher voltage than specific value will damage insulating material and shorten its life.
- (5) This power choke coil must not be used in wet condition by water, coffee or any liquid because insulation strength becomes very low in this condition.
- (6) Please consult our company to confirm the reliability of the process required to wash or use or exposure to a chemical solvent used in this product.

10. Packaging Information

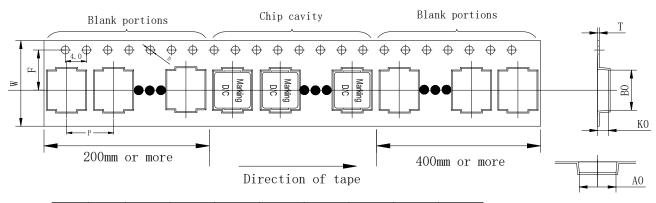
(1) Reel Dimension





Type A(mm)		B(mm)	C(mm)	D(mm)	
13"x16mm	16.4+2/-0	100±2	13+0.5/-0.2	330	

(2) Tape Dimension

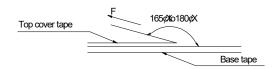


Series	Size	Bo(mm)	Ao(mm)	Ko(mm)	P(mm)	W(mm)	F(mm)	t(mm)	D(mm)
TMPA	0605	7.7±0.1	7.0±0.1	5.3±0.1	12.0±0.1	16±0.3	7.5±0.1	0.35±0.05	1.5±0.1

(3) Packaging Quantity

TMPA	0605	
Chip / Reel	800	
Inner box	1600	
Carton	6400	

(4) Tearing Off Force



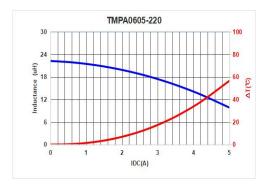
The force for tearing off cover tape is 10 to 130 grams in the arrow direction under the following conditions(referenced ANSI/EIA-481-D-2008 of 4.11 stadnard).

Room Temp.	Room Humidity	Room atm	Tearing Speed
(℃)	(%)	(hPa)	mm/min
5~35	45~85	860~1060	

Application Notice

- · Storage Conditions
- To maintain the solderability of terminal electrodes:
- 1. TAI-TECH products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
- 3. Recommended products should be used within 12 months form the time of delivery.
- 4. The packaging material should be kept where no chlorine or sulfur exists in the air.
- Transportation
 - 1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
 - 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
 - 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

11. Typical Performance Curves



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